

DATE 2018 MEDIA PARTNERS



DATE 2018 EXHIBITORS

<u>Company</u>	<u>Booth No.</u>
Advantest Europe GmbH	8
Arm Ltd.	6
cfaed Excellence Cluster / CRC HAEC	Campus 5G
Circuits Multi-Projects (CMP)	9
City of Dresden, Economic Development Office	1
COEMS - Continuous Observation of Embedded Multicore Systems	EP 1
COSEDA Technologies GmbH	14
Dream Chip Technologies GmbH	Campus FDSOI
dReDBox (Disaggregated Data Center in a Box)	EP 2
EUROPRACTICE	10
Fraunhofer Institute for Integrated Circuits IIS	Campus FDSOI
GLOBALFOUNDRIES	Campus FDSOI
HiPEAC - European Network on High Performance and Embedded Architecture and Compilation	EP 3
IDT Europe GmbH	Campus Autonomous Driving/ Mobility
MathWorks	7
Mentor, A Siemens Business	5
Platform Design Automation, Inc.	13
Racyics GmbH	Campus FDSOI
River Publishers	11
Springer Nature	2
TETRAMAX	EP 3

Texas Instruments	12
University Booth	16
X-FAB Semiconductor Foundries	Campus Autonomous Driving/ Mobility